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In re the Application of: Yoshikazu MIWA et al.

Group Art Unit: 1722

Date: January 3, 2006

Serial Number: 10/720,081

Examiner:

Filed: November 25, 2003

Confirmation Number: 4933

For: MOLDING MANUFACTURING METHOD AND APPARATUS

Attorney Docket Number:

053434

Customer Number:

38834

<u>INFORMATION DISCLOSURE STATEMENT</u> <u>UNDER 37 C.F.R. §1.97(b)</u>

Commissioner for Patents

P. O. Box 1450

Alexandria, VA 22313-1450

Sir:

In compliance with 37 C.F.R. §1.56, Applicants direct the attention of the Patent and Trademark Office to the documents listed on the attached PTO/SB/08. This paper is being filed within the time periods set forth in 37 C.F.R. §1.97(b). A copy of each non-U.S. document is enclosed herewith. Also attached are two Japanese Office Actions accompanied by English Translations.

If there are any fees due in connection with the filing of this paper, please charge Deposit Account No. 50-2866.

Respectfully submitted,

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Enclosures:

PTO/SB/08

(2) Japanese Office Actions with English Translations

(7) References

Combined Form PTO/SB/08A&B

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| | NT BY APPLICANT | Filing Date | November 25, 2003 |
| | | First Named Inventor | Yoshikazu MIWA et al |
| (use as man | y sheets as necessary) | Art Unit | 1722 |
| · | | Examiner Name | |
| Sheet | of | Attorney Docket Number | 053434 |

Complete if Known

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| Examiner Cite | | Document | Number | Publication Date | | |
| | No.1 | Number | Kind Code ² (if known) | MM-DD-YYYY | Name of Patentee or Applicant of Cited Document | |
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| Examiner Initials* | Cite No.1 | Foreign Patent Document | | | Publication Date | Name of Patentee or | |
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| | | NON PATENT LITERATURE DOCUMENTS | |
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| Examiner Initials* | Cite No.1 | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published. | Translation ⁶ |
| | 8 | Japanese Office Action mailing date: October 4, 2005 with English translation issued for corresponding Japanese Application No. JP-A-2002-342649. | |
| | 9 | Japanese Office Action mailing date: October 4, 2005 with English translation issued for corresponding Japanese Application No. JP-A-2002-342648. | |
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| Examiner Signature Date Considered | 1 |

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Applicant's unique citation designation number (optional). ²See Kind Codes of USPTO Patent Documents at www.uspto.gov, MPEP 901.04 or in the comment box of this document. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to indicate here if English language Translation is attached.